



# Photocoupler

## Product Data Sheet

### LTV-217-G

(Half Pitch LO Own Brand -  
1CH Halogen Free Series)

Spec No.: DS70-2009-0016

Effective Date: 09/06/2012

Revision: A

**LITE-ON DCC**

**RELEASE**

BNS-OD-FC001/A4

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## FEATURES

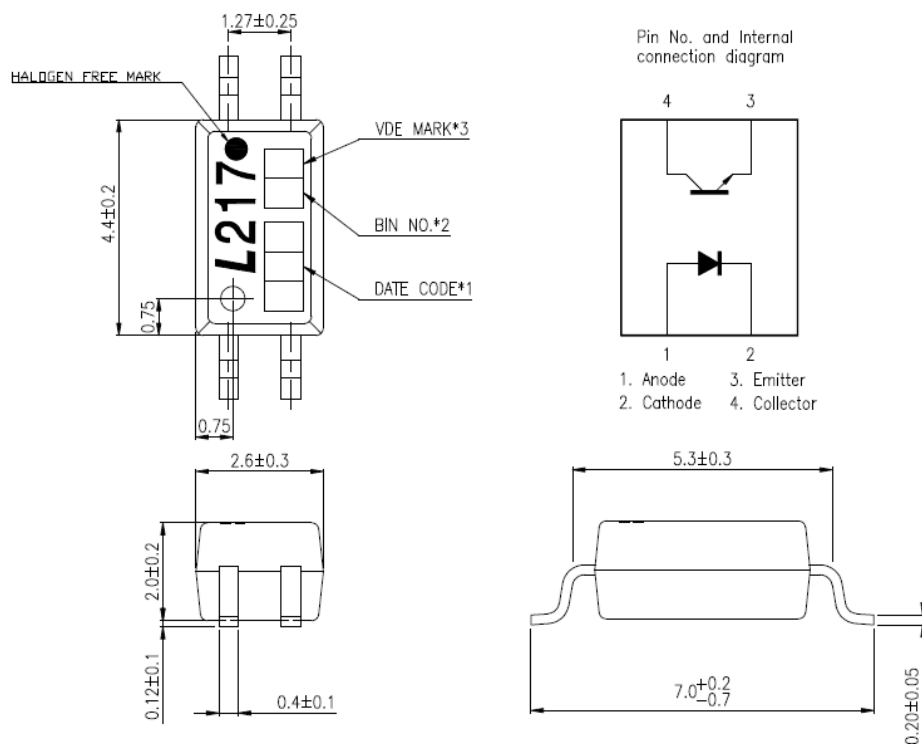
- \* Current transfer ratio  
( CTR : MIN. 50% at  $I_F = 5\text{mA}$ ,  $V_{CE} = 5\text{V}$  )
- \* Isolation voltage between input and output LTV-217 Series  
( Viso = 3.75 KVrms )
- \* Employs double transfer mold technology
  
- \* Safety Approval  
UL, cUL, CSA, FIMKO, VDE\* Approved  
(\*Requires “V” ordering option)
  
- \* RoHS compliance

## APPLICATIONS

- \* Hybrid substrates that require high density mounting.
- \* Programmable controllers
- \* System appliances, measuring instruments

## OUTLINE DIMENSIONS

### LTV-217-G:



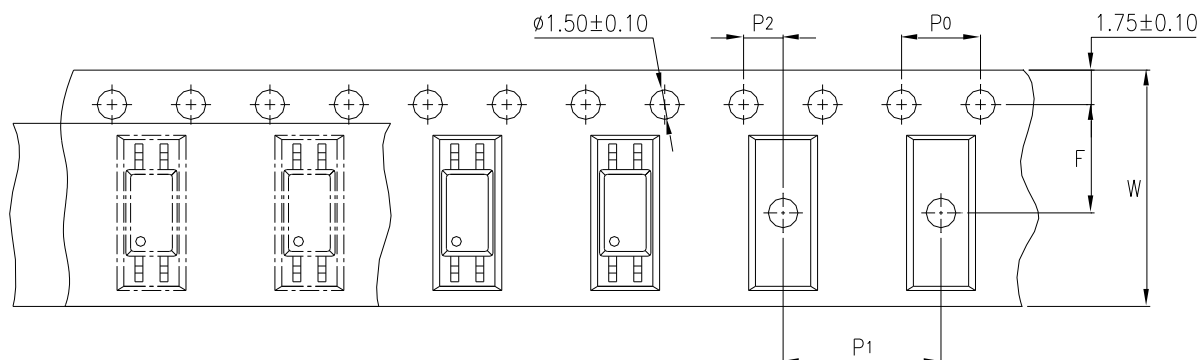
\*1. 3-digit date code.

\*2. Rank shall be or shall not be marked.

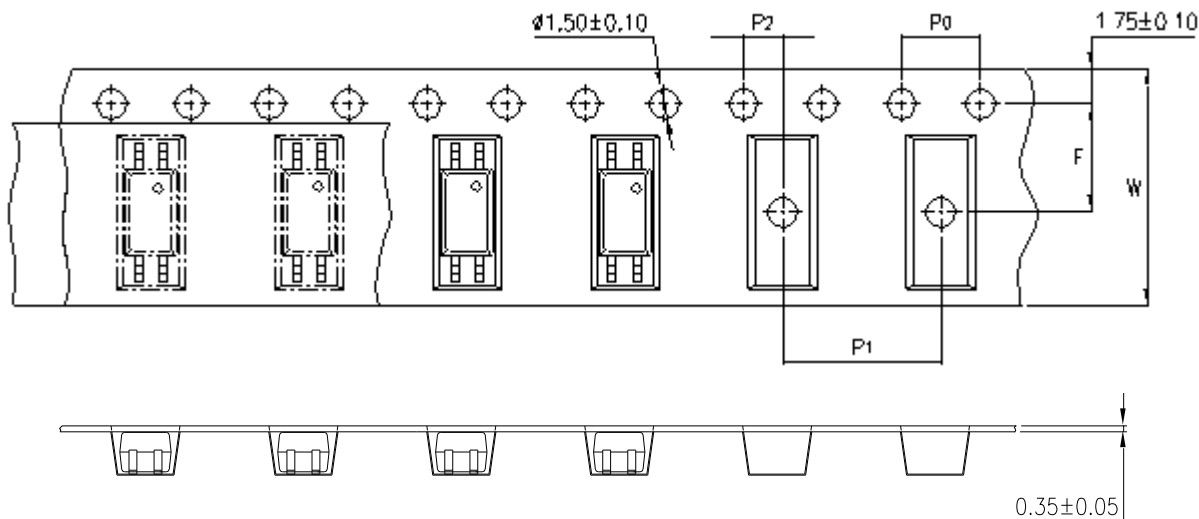
\*3. VDE mark, only appears on devices ordered "V" option.

## TAPING DIMENSIONS

### LTV-217



### LTV-217-TP1



| Description                            | Symbol         | Dimension in mm (inches) |
|----------------------------------------|----------------|--------------------------|
| Tape wide                              | W              | 12 ± 0.3 (.47)           |
| Pitch of sprocket holes                | P <sub>0</sub> | 4 ± 0.1 (.15)            |
| Distance of compartment                | F              | 5.5 ± 0.1 (.217)         |
| Distance of compartment to compartment | P <sub>1</sub> | 2 ± 0.1 (.079)           |
|                                        | P <sub>1</sub> | 8 ± 0.1 (.315)           |

### Quantities per Reel :

|                  |         |
|------------------|---------|
| Package Type     | LTV-217 |
| Quantities (pcs) | 3000    |

## ABSOLUTE MAXIMUM RATING

( Ta = 25°C )

| PARAMETER                |                             | SYMBOL           | RATING     | UNIT             |
|--------------------------|-----------------------------|------------------|------------|------------------|
| INPUT                    | Forward Current             | I <sub>F</sub>   | 50         | mA               |
|                          | Reverse Voltage             | V <sub>R</sub>   | 6          | V                |
|                          | Power Dissipation           | P                | 70         | mW               |
| OUTPUT                   | Collector - Emitter Voltage | V <sub>CEO</sub> | 70         | V                |
|                          | Emitter - Collector Voltage | V <sub>ECO</sub> | 7          | V                |
|                          | Collector Current           | I <sub>C</sub>   | 50         | mA               |
|                          | Collector Power Dissipation | P <sub>C</sub>   | 150        | mW               |
| Total Power Dissipation  |                             | P <sub>tot</sub> | 200        | mW               |
| *1 Isolation Voltage     |                             | V <sub>iso</sub> | 3000       | V <sub>rms</sub> |
| Operating Temperature    |                             | T <sub>opr</sub> | -55 ~ +110 | °C               |
| Storage Temperature      |                             | T <sub>stg</sub> | -55 ~ +150 | °C               |
| *2 Soldering Temperature |                             | T <sub>sol</sub> | 260 (10s)  | °C               |

\*1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

\*2. For 10 Seconds

## ELECTRICAL - OPTICAL CHARACTERISTICS

( Ta = 25°C )

| PARAMETER                |                                      | SYMBOL               | MIN.               | TYP.               | MAX. | UNIT | CONDITIONS                                                                 |
|--------------------------|--------------------------------------|----------------------|--------------------|--------------------|------|------|----------------------------------------------------------------------------|
| INPUT                    | Forward Voltage                      | V <sub>F</sub>       | —                  | 1.2                | 1.4  | V    | I <sub>F</sub> =20mA                                                       |
|                          | Reverse Current                      | I <sub>R</sub>       | —                  | —                  | 10   | μA   | V <sub>R</sub> =4V                                                         |
|                          | Terminal Capacitance                 | C <sub>t</sub>       | —                  | 30                 | 250  | pF   | V=0, f=1KHz                                                                |
| OUTPUT                   | Collector Dark Current               | I <sub>CEO</sub>     | —                  | —                  | 100  | nA   | V <sub>CE</sub> =50V, I <sub>F</sub> =0                                    |
|                          | Collector-Emitter Breakdown Voltage  | BV <sub>CEO</sub>    | 80                 | —                  | —    | V    | I <sub>C</sub> =0.1mA<br>I <sub>F</sub> =0                                 |
|                          | Emitter-Collector Breakdown Voltage  | BV <sub>ECO</sub>    | 7                  | —                  | —    | V    | I <sub>E</sub> =10μA<br>I <sub>F</sub> =0                                  |
| TRANSFER CHARACTERISTICS | Collector Current                    | I <sub>C</sub>       | 2.5                | —                  | 30   | mA   | I <sub>F</sub> =5mA<br>V <sub>CE</sub> =5V                                 |
|                          | *1 Current Transfer Ratio            | CTR                  | 50                 | —                  | 600  | %    |                                                                            |
|                          | Collector-Emitter Saturation Voltage | V <sub>CE(sat)</sub> | —                  | —                  | 0.4  | V    | I <sub>F</sub> =8mA<br>I <sub>C</sub> =2.4mA                               |
|                          | Isolation Resistance                 | R <sub>iso</sub>     | 5×10 <sup>10</sup> | 1×10 <sup>11</sup> | —    | Ω    | DC500V<br>40 ~ 60% R.H.                                                    |
|                          | Floating Capacitance                 | C <sub>f</sub>       | —                  | 0.6                | 1    | pF   | V=0, f=1MHz                                                                |
|                          | Response Time (Rise)                 | t <sub>r</sub>       | —                  | 2                  | 18   | μs   | V <sub>CE</sub> =10V, I <sub>C</sub> =2mA<br>R <sub>L</sub> =100Ω, f=100Hz |
|                          | Response Time (Fall)                 | t <sub>f</sub>       | —                  | 3                  | 18   | μs   |                                                                            |
|                          | Turn-On Time                         | t <sub>on</sub>      |                    | 3                  |      | μs   |                                                                            |
|                          | Turn-Off Time                        | t <sub>off</sub>     |                    | 3                  |      | μs   |                                                                            |

$$*1 \text{ CTR} = \frac{I_C}{I_F} \times 100\%$$

**RANK TABLE OF CURRENT TRANSFER RATIO CTR**

| MODEL NO.  | RANK MARK                            | CTR ( % ) |
|------------|--------------------------------------|-----------|
| LTV-217    | A                                    | 80 ~ 160  |
|            | B                                    | 130 ~ 260 |
|            | C                                    | 200 ~ 400 |
|            | D                                    | 300 ~ 600 |
|            | A or B or C or D or No mark          | 50 ~ 600  |
| CONDITIONS | IF = 5 mA<br>VCE = 5 V<br>Ta = 25 °C |           |

## CHARACTERISTICS CURVES

Figure 1. Collector Power Dissipation vs. Ambient Temperature

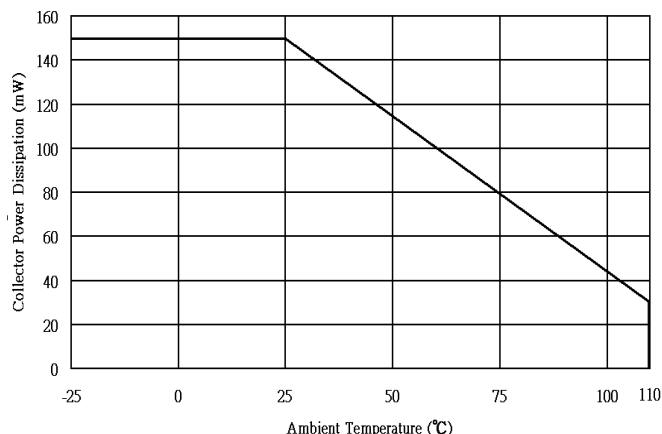


Figure 2. Forward Current vs. Ambient Temperature

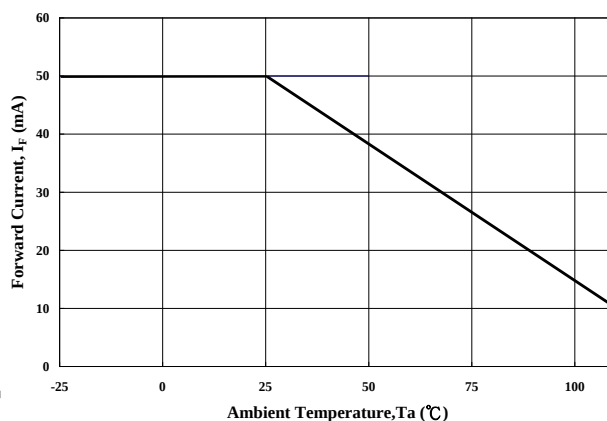


Figure 3. Forward Current vs. Forward Voltage

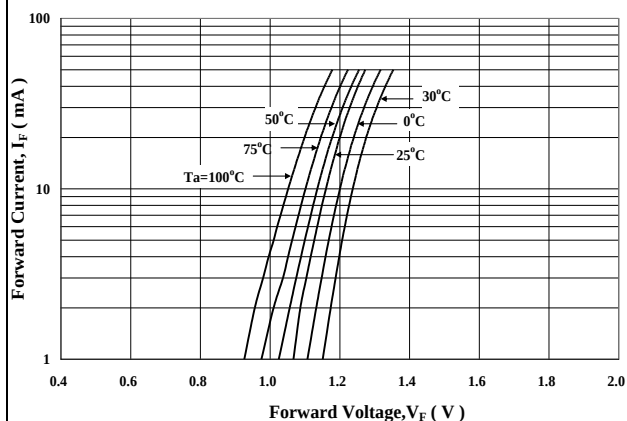


Figure 4. Forward Voltage Temperature Coefficient vs. Forward Current

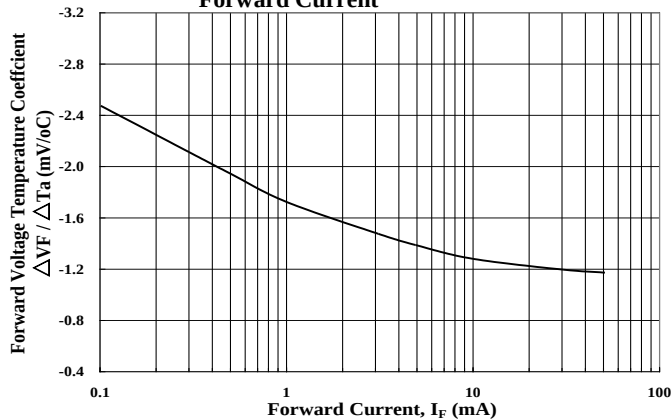


Figure 5. Pulse Forward Current vs. Duty Cycle Ratio

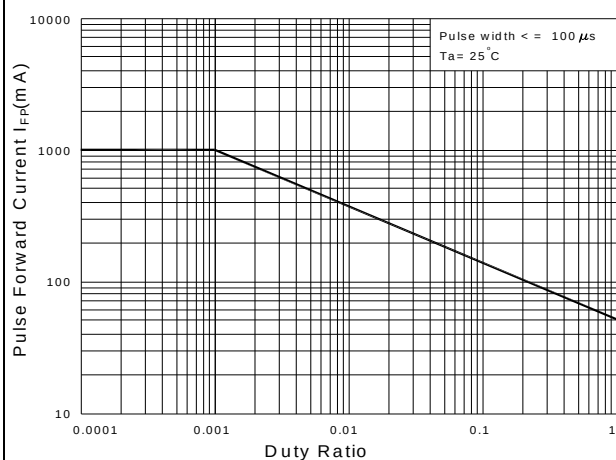
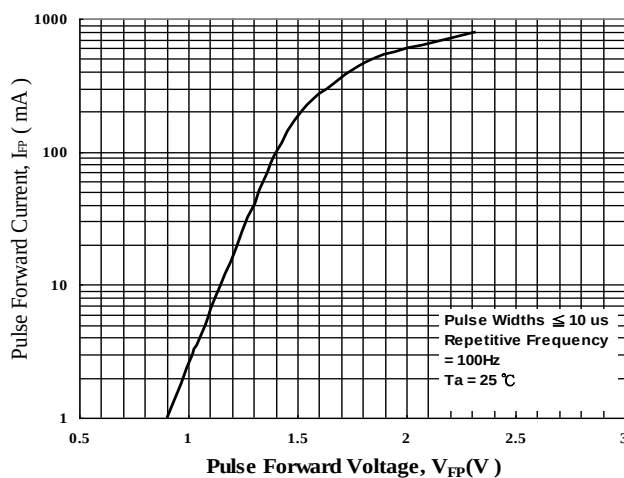


Figure 6. Pulse Forward Current vs. Pulse Forward Voltage





## CHARACTERISTICS CURVES

Figure 7. Collector-Emitter Saturation Voltage vs. Forward Current

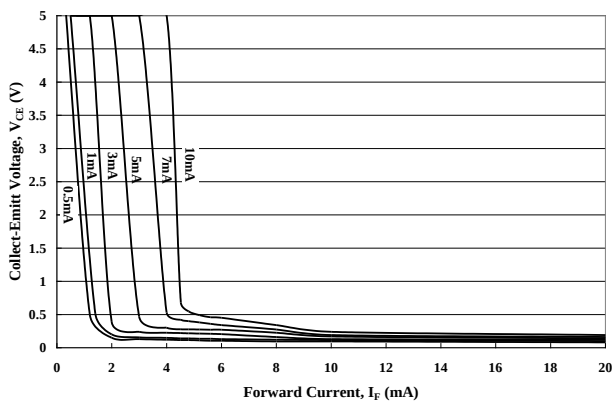


Figure 8. Collector Current vs. Collector-Emitter Voltage

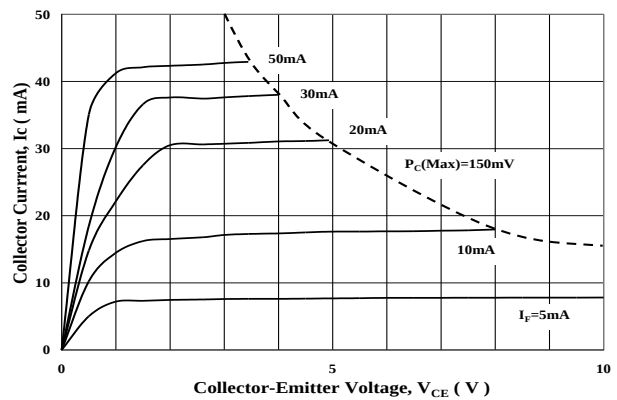


Figure 9. Collector Current vs. Small Collector-Emitter Voltage

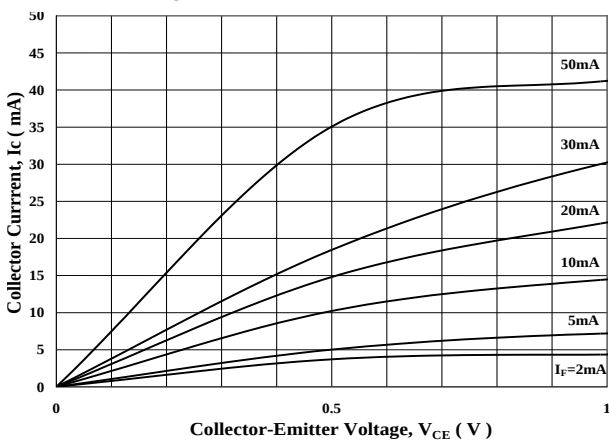


Figure 10. Collector Current vs. Forward Current

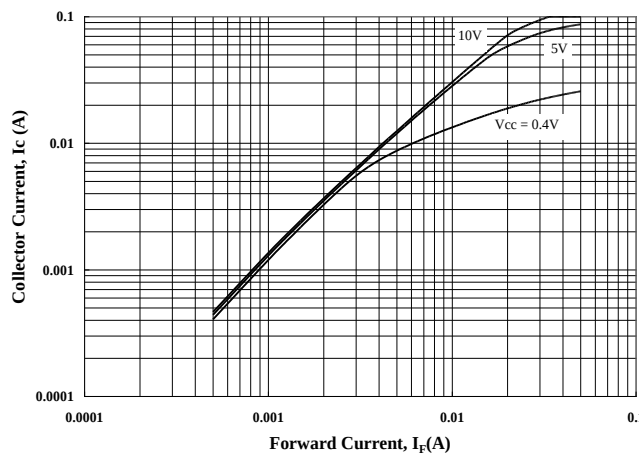


Figure 11. Collector Dark Current vs. Ambient Temperature

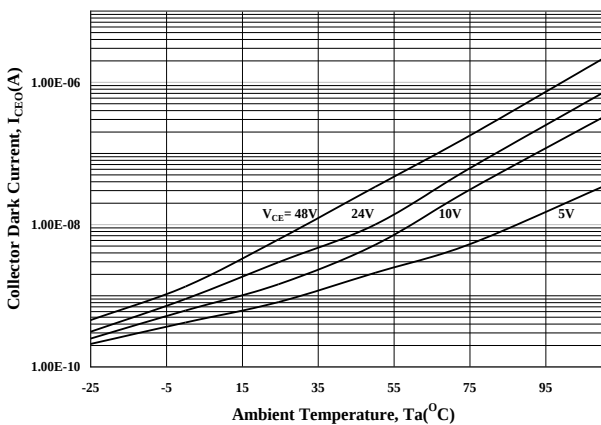
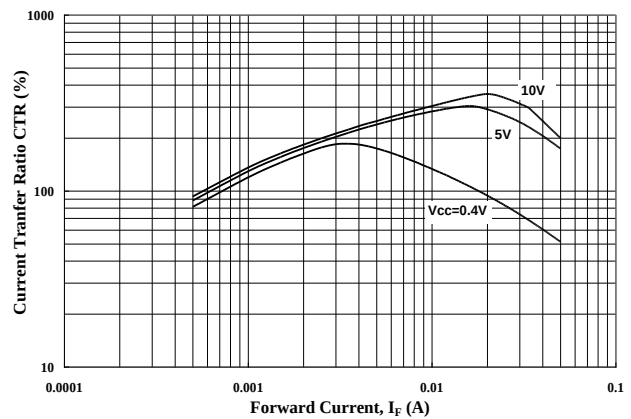


Figure 12. Current Transfer Ratio vs. Forward Current



## CHARACTERISTICS CURVES

Figure 13. Collector-Emitter Saturation Voltage vs. Ambient Temperature

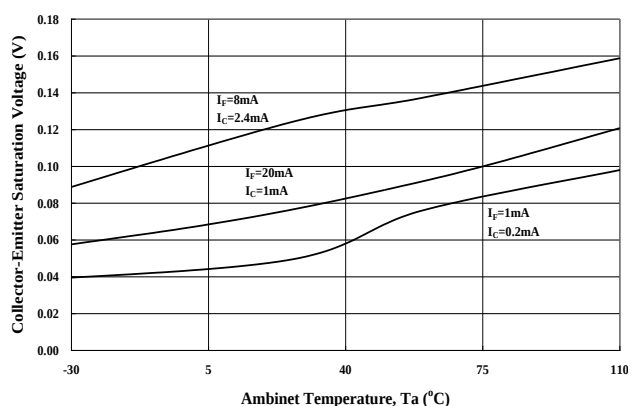


Figure 14. Collector Current vs. Ambient Temperature

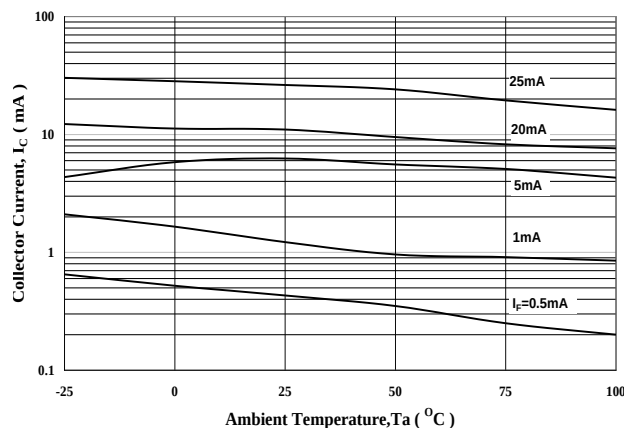


Figure 15. Switching Time vs. Load Resistance

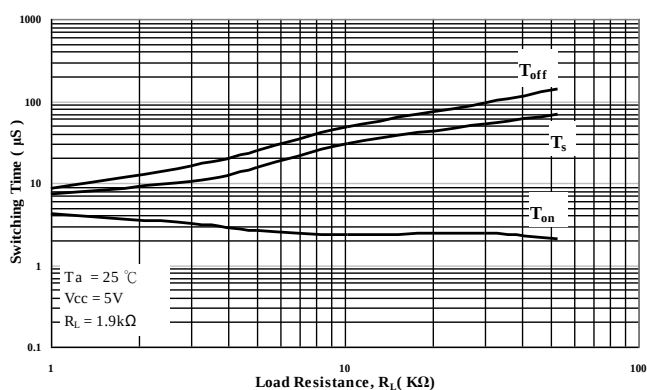


Figure 16. Switching Time vs. Ambient Temperature

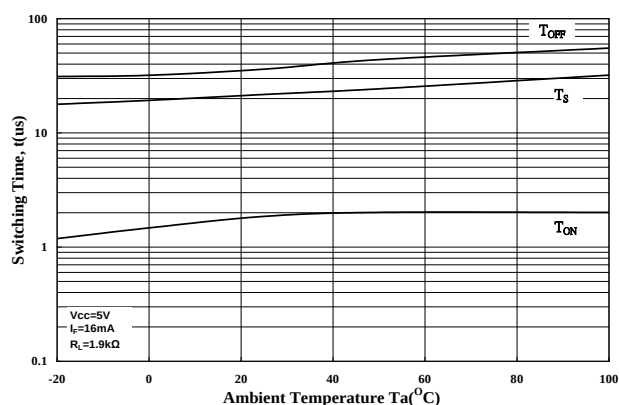
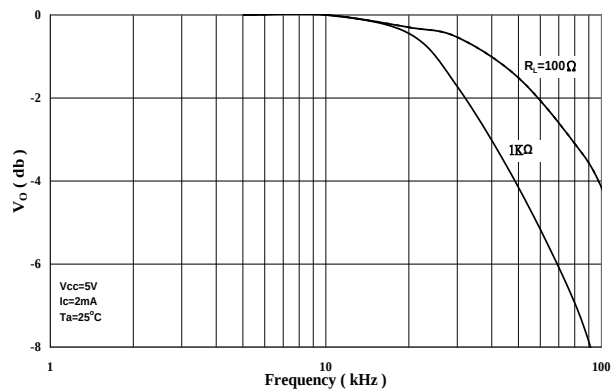
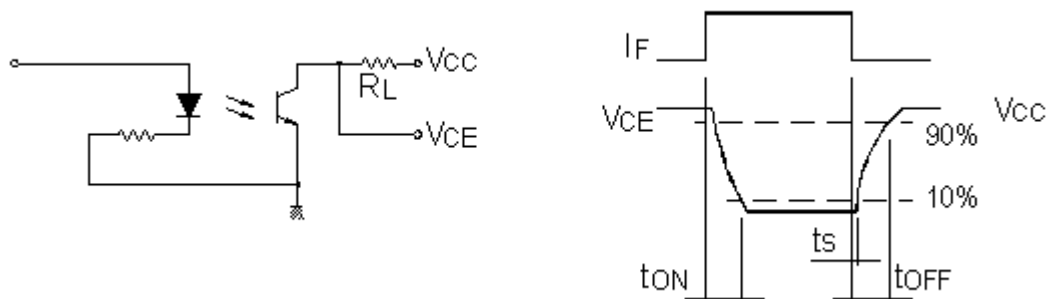


Figure 17. Frequency Response



## SWITCHING TIME TEST CIRCUIT



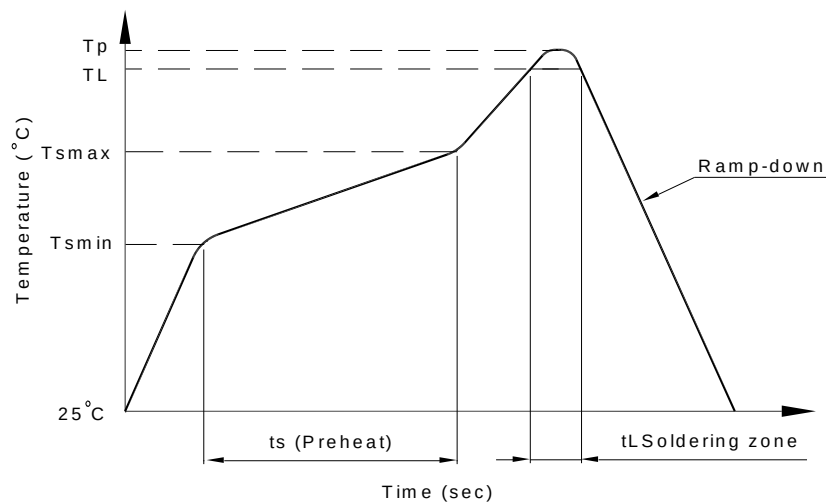
## TEMPERATURE PROFILE OF SOLDERING REFLOW

(1) One time soldering reflow is recommended within the condition of temperature and time profile shown below.

1. Wave solder
  - $260^{\circ}\text{C} / 10 \text{ sec.}$

2. IR Reflow

| Profile item                     | Conditions                              |
|----------------------------------|-----------------------------------------|
| Preheat                          |                                         |
| - Temperature Min ( $T_{Smin}$ ) | $150^{\circ}\text{C}$                   |
| - Temperature Max ( $T_{Smax}$ ) | $180^{\circ}\text{C}$                   |
| - Time (min to max) ( $t_s$ )    | $90 \pm 30^{\circ}\text{C}$             |
| Soldering zone                   |                                         |
| - Temperature ( $T_L$ )          | $250^{\circ}\text{C}$                   |
| - Time ( $t_L$ )                 | $10 \sim 15 \text{ sec}$                |
| Peak Temperature ( $T_P$ )       | $260^{\circ}\text{C}$                   |
| Ramp-down rate                   | $3 \sim 6^{\circ}\text{C} / \text{sec}$ |



## **TEMPERATURE PROFILE OF SOLDERING REFLOW**

(2) When using another soldering method such as infrared ray lamp, the temperature may rise partially in the mold of the device.

Keep the temperature on the package of the device within the condition of above (1)

(3) When using another soldering method such as infrared ray lamp, the temperature may rise partially in the mold of the device.

Keep the temperature on the package of the device within the condition of above (1)

### **Notes:**

- Lite-On is continually improving the quality, reliability, function or design and Lite-On reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.